# XRP6272



2A 5V-Adjustable Low Dropout Voltage Regulator

Rev. 1.2.0

#### November 2011

### **GENERAL DESCRIPTION**

The XRP6272 is a low dropout voltage regulator capable of a constant output current up to 2 Amps. A wide 1.8V to 6V input voltage range allows for single supply operations from industry standard 1.8V, 2.8V, 3.3V, and 5V power rails as well as the 5.8V rail.

With better than ±2% output voltage accuracy, low output noise and high Power Supply Rejection Ratio (PSRR), the XRP6272 is perfectly suited for powering RF circuitries. Optimized for use with small low cost ESR ceramic output capacitors and featuring a low 30µA quiescent current, this device is also adequate for use in battery powered portable equipments. The XRP6272 operates by default as a 5V fixed output voltage regulator while usage of an external resistors divider allows adjustable out voltages as low as 0.7V. An Enable function, Power Good flag and output noise reduction pin complete the feature set.

Built-in current limit and thermal protections insure safe operations under abnormal operating conditions.

The XRP6272 is offered in RoHS compliant, "green"/halogen free 5-pin TO-252 and 8-pin exposed pad SOIC packages.

TYPICAL APPLICATION DIAGRAM

#### APPLICATIONS

- Networking Equipments
- **RF Circuitry Power Supplies**
- Set-top box Equipments
- Portable Equipments

#### **FEATURES**

- Guaranteed 2A Output Current
  - Low 550mV Dropout at 3.3V/2A
- 1.8V to 6V Single Input Voltage Range
  - Fixed 5V and Adjustable Output Voltage
  - ±2% Output Voltage Accuracy
- 30µA Quiescent Current
- Power Good and Enable Functions
- 70dB Power Supply Rejection Ratio
- Low Output Noise
- 0.01µA Shutdown Current
- Current Limit and Thermal Protection
- RoHS compliant "Green"/Halogen Free 5-pin TO-252 and 8-pin Exposed pad SOIC Packages



Fig. 1: XRP6272 Application Diagram



### **ABSOLUTE MAXIMUM RATINGS**

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V <sub>IN</sub> , EN, BP	7.0V
Storage Temperature	65°C to 150°C
Power Dissipation	Internally Limited
Lead Temperature (Soldering, 10 sec)	260°C
Junction Temperature	150°C
ESD Rating (HBM - Human Body Model).	2kV
ESD Rating (MM - Machine Model)	500V

### **OPERATING RATINGS**

Input Voltage Range V <sub>IN</sub>	1.8V to 6V
Operating Temperature Range40	°C to 85°C
Thermal Resistance	
θ <sub>JA</sub> (5-Pin TO-252)	100°C/W
θ <sub>JC</sub> (5-Pin TO-252)	8°C/W
θ <sub>JA</sub> (8-pin HSOIC)	60°C/W
θ <sub>JC</sub> (8-pin HSOIC)	15°C/W

### ELECTRICAL SPECIFICATIONS

Specifications with standard type are for an Operating Junction Temperature of  $T_J = 25^{\circ}$ C only. Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at  $T_J = 25^{\circ}$ C, and are provided for reference purposes only. Unless otherwise indicated,  $V_{IN} = V_{OUT} + 1V$ ,  $C_{IN} = 4.7\mu$ F,  $C_{OUT} = 4.7\mu$ F or  $10\mu$ F (Note 1),  $C_{BYP} = 22n$ F,  $T_J = 25^{\circ}$ C.

Parameter	Min.	Тур.	Max.	Units	Conditions
Input Voltage	1.8		6.0	V	
Output Voltage Tolerance	-2		+2	%	$I_{OUT} = 1 m A$
Continuous Output Current	2			А	$V_{IN} \ge 2.3V$
Ground Current		30	50	μA	$V_{EN} \ge 1.6V$ , No Load
Ground Current		30	50	μΑ	$V_{\text{EN}} \ge 1.6V$ , $I_{\text{OUT}} = 300 \text{mA}$
Standby Current		0.01	0.5	μA	$V_{EN} = 0$
Line Regulation		3	15	mV	$V_{IN} = V_{OUT} + 1V$ to 6V, $I_{OUT} = 1mA$
Load Regulation		5	15	mV	$I_{OUT} = 1mA$ to 2A
Output Current Limit	2.2	3.0	3.9	А	
Current Fold Back		1.0		А	
		960			$I_{OUT} = 2A, V_{OUT} = 1.2V$
		700	900	mV	$I_{OUT} = 2A, V_{OUT} = 1.8V$
Dropout Voltage (Note 2)		550	700	111V	$I_{OUT} = 2A, V_{OUT} = 3.3V$
		480	600		$I_{OUT} = 2A, V_{OUT} = 5.0V$
Reference Voltage Tolerance	0.686	0.7	0.714	V	
ADJ Pin Current		10	100	nA	$V_{ADJ} = V_{REF}$
ADJ Pin Threshold	0.05	0.1	0.2	V	
Enable Turn-On Threshold	1.6			V	Output ON
Enable Turn-Off Threshold			0.4	V	Output OFF
Shutdown Pin Current		0	0.5	μA	$V_{EN} = 0$
Shutdown Exit Delay Time		100		μs	
Max Output Discharge Resistance to GND during Shutdown		20	100	Ω	
PGOOD Rise Threshold		90	93	%	
PGOOD Hysteresis	3	10		%	
PGOOD Delay	0.5		5	ms	
PGOOD Sink Capability		0.2	0.4	V	$I_{PGOOD} = 10 \text{mA}$
Ripple Rejection		70		dB	f=1KHz, Ripple=0.5Vp-p
Output Noise Voltage		24		μVrms	C <sub>BP</sub> = 22nF, f=10Hz ~100KHz
Temperature Coefficient		50		ppm/°C	
Thermal Shutdown Temperature		150		°C	$V_{IN} = V_{OUT} + 1V$
Thermal Shutdown Hysteresis		20		°C	
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Note 1: In the case of V\_{OUT}  $\leq$  1.8V, C\_{OUT} = 10µF is recommended.

Note 2: Dropout Voltage is defined as input voltage minus output voltage when the output voltage drops by 1% of its nominal value at  $V_{IN} = V_{OUT} + 1V$ .

Note 3:  $V_{IN (min)}$  is the higher value of ( $V_{OUT}$  + Dropout Voltage) or 1.8V.

### **BLOCK DIAGRAM**



Fig. 2: XRP6272 Block Diagram

### **PIN ASSIGNMENT**



Fig. 3: XRP6272 Pin Assignment



### **PIN DESCRIPTION**

Name	SOIC-8	TO-252	Description
EN	1	1	Enable Pin. Minimum 1.6V to enable the device. Maximum 0.4V to shutdown the device.
VIN	2	2	Power Input Pin. Must be closely decoupled to GND pin with a $4.7\mu F$ or greater ceramic capacitor.
VOUT	3	4	Regulator Output pin.
ADJ	4	5	Adjustable Pin. Output Voltage can be set by external feedback resistors when using a resistive divider. Or, connect ADJ to GND for VOUT = 5V, set by internal feedback resistors.
GND	5, 8	3	Ground Signal
BP	6	-	Bypass pin. Connect a 22nF capacitor to GND to reduce output noise. Bypass pin can be left floating if not necessary.
PGOOD	7	-	Power Good open Drain Output.
GND	Exposed Pad	Tab	Connect to GND.

### **ORDERING INFORMATION**

Part Number	Temperature Range	Marking	Package	Packing Quantity	Note 1	Note 2
XRP6272ITC5TR-F	-40°C≤T <sub>A</sub> ≤+85°C	EXAR XRP6272ITC5 YYWWF X	5-pin TO-252	$2K/1abe \alpha Reel$	RoHS Compliant Halogen Free	
XRP6272IDBTR-F	-40°C≤T <sub>A</sub> ≤+85°C	XRP6272I YYWWF XXXX	8-pin HSOIC	$2.5K/1abe \alpha$ Reel	RoHS Compliant Halogen Free	

"YY" = Year - "WW" = Work Week - "X" = Lot Number; when applicable.



### **TYPICAL PERFORMANCE CHARACTERISTICS**

All data taken at  $V_{IN} = V_{OUT} + 1V$ ,  $T_J = T_A = 25^{\circ}$ C,  $C_{IN} = 4.7\mu$ F,  $C_{OUT} = 4.7\mu$ F or  $10\mu$ F (Note 1) unless otherwise specified.



Fig. 4: GND Current vs. VIN at VOUT=1.8V, No Load



Fig. 6: GND Current vs. VIN at VOUT=1.8V, 300mA



Fig. 8: GND Current vs. Temp. at VOUT=1.8V, No Load



Fig. 5: GND Current vs. VIN at VOUT=3.3V, No Load



Fig. 7: GND Current vs. VIN at VOUT=3.3V, 300mA



Fig. 9: GND Current vs. Temp. at VOUT=3.3V, No Load





Fig. 10: Dropout Voltage at VOUT = 1.8V



Fig. 12: Dropout Voltage at VOUT = 5.0V



Fig. 14: Load Transient Response at VOUT=3.3V, VIN=4.3V





Fig. 13: Load Transient Response at VOUT=1.8V, VIN=2.8V



Fig. 15: Load Transient Response at VOUT=5V, VIN=6V







Ch4 500mA Ω∿





## APPLICATION INFORMATION

The XRP6272 is a low-dropout voltage regulator with low quiescent current, low noise and high PSRR. It can support load current up to 2A. It incorporates current-limit and thermal protection features.

### **TYPICAL APPLICATION SCHEMATIC**



### **PROGRAMMING THE OUTPUT VOLTAGE**

XRP6272's internal feedback resistors set the output voltage  $V_{OUT}$  to 5V when the ADJ pin is connected to GND. Alternatively; the output voltage is adjustable via the external feedback resistor network R1 and R2 by calculating the following formula:

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R1}{R2}\right)$$

where,  $V_{\text{REF}}$  is the reference voltage set internally at 0.7V nominal.

### **INPUT & OUTPUT CAPACITORS**

XRP6272 is optimized for use with ceramic capacitors. To ensure stability of the device,

an output ceramic capacitor of at least  $4.7\mu$ F or  $10\mu$ F (for V<sub>OUT</sub>  $\leq$  1.8V) is recommended. An input capacitor of  $4.7\mu$ F is recommended.

X5R or X7R ceramic capacitors are recommended as they have the best temperature and voltage characteristics.

### NOISE BYPASS CAPACITOR

A 22nF bypass capacitor at BP pin can reduce output voltage noise. This pin can be left floating if it is unnecessary.

### THEORY OF OPERATION

#### SHUTDOWN

By connecting EN pin to GND, the XRP6272 can be shutdown to reduce the supply current to  $0.01\mu$ A (typ.). In this mode, the output voltage of XRP6272 is equal to 0V.

#### **CURRENT LIMIT**

The XRP6272 includes current limit protection feature, which monitors and controls the maximum output current. If the output is overloaded or shorted to ground, this can protect the device from being damaged.

#### THERMAL PROTECTION

The XRP6272 includes a thermal protection feature that protects the IC by turning off the pass transistor when the maximum junction temperature  $T_J$  exceeds 150°C.



#### **POWER DISSIPATION**

The power dissipation across the device can be calculated as:

$$P_D = I_{OUT} \times (V_{IN} - V_{OUT})$$

The total junction temperature is calculated as:

$$T_J = T_A + P_D \times \theta_{JA}$$

where,  $T_J$  is the junction temperature,  $T_A$  is the ambient temperature and  $\Theta_{JA}$  is the thermal resistance between junction to ambient.

There is a temperature rise associated with this power dissipated while operating in a given ambient temperature. If the calculated junction temperature exceeds maximum junction temperature specification, then the built-in thermal protection feature is triggered as described previously.

To insure reliable performance, the maximum allowable power dissipation for a given ambient temperature must be considered and it can be calculated as follows:

$$P_{D(MAX)} = (T_{J(MAX)} - (T_A)) / \theta_{JA}$$

where,  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature and  $\Theta_{JA}$  is the thermal resistance between junction to ambient. In order to insure the best thermal flow, proper mounting of the IC is required.

#### LAYOUT CONSIDERATION

- 1. Connect the bottom-side pad to a large ground plane for good thermal conductivity and to reduce the thermal resistance of the device.
- 2. The input capacitor  $C_{IN}$  and output capacitor  $C_{OUT}$  must be placed as close as possible to the pins  $V_{IN}$  and  $V_{OUT}$  respectively.
- 3. Use short wires to connect the power supply to pins  $V_{\rm IN}$  and GND on the board.



## **TYPICAL APPLICATIONS**

### **APPLICATION 1**



#### **APPLICATION 2**



Fig. 24: 5.8V to 5V RF Stage Low Noise Power Supply

### **APPLICATION 3**



Fig. 25: 2.7V Min to 1.8V / 2A Power Supply



## PACKAGE SPECIFICATION

### TO-252-5L



Note: 1. Refer to JEDEC TO-252AD and AB.

- Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3. Dimension "D" does not include inter-lead flash or protrusions.
- Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



#### **EXPOSED PAD 8-PIN SOIC**



S Y	SOP-8 Exposed Pad(Heat Sink)				
- М В О L	MILLIMETERS				
O L	MIN.	MAX.			
Α	1.35	1.75			
A1	0.00	0.15			
В	0.31	0.51			
С	0.17	0.25			
D	4.80	5.00			
Е	3.80	4.00			
e	1.27 BSC				
Н	5.80	6.20			
h	0.25	0.50			
L	0.40	1.27			
q	0°	8°			
D1	1.5	3.5			
E1	1.0	2.55			

Note : 1. Refer to JEDEC MS-012E.

- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3. Dimension "E" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



### **REVISION HISTORY**

Revision	Date	Description		
1.1.0	10/14/2011	Initial release of Data Sheet		
1.2.0	11/30/2011	Corrected pin assignment package drawing		

### FOR FURTHER ASSISTANCE

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